Directional Coupler 5 - 55 GHz



MACP-011113 Rev. V3

Features

Broadband: 5 to 55 GHz

Low Insertion Loss: 1 dB @ 50 GHz High Isolation: 35 dB @ 30 GHz

Coupling Factor: 18 dB On-Chip 50 Ω Termination

Miniature Lead-Free Surface Mount Package

RoHS* Compliant

Applications

Test and Measurement

Description

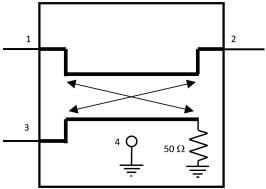
The MACP-011113 is a fully integrated 5 - 55 GHz directional coupler with a 50 Ohm on-chip termination, offering best in class RF performance in a miniature package.

MACOM's proprietary HMICTM process enables market leading lightweight passive components. MACP-011113 weighs just 2 mg.

Ordering Information^{1,2}

Part Number	Package
MACP-011113	Gel Pack
MACP-011113-TR0100	100 Piece Reel
MACP-011113-TR0500	500 Piece Reel
MACP-011113-SB1	Sample Board

Functional Schematic



Pin Names

Pin#	Function		
1, 2	R _{FIN} / RF _{OUT}		
3	Coupled Port		
4	GND ³		

3. The exposed die backside GND metal must be connected to RF, DC and thermal ground.

Pin Description

Pin 1	Pin 2	Pin 3	Pin 4
Input	Output	Coupled	Ground

^{1.} Reference Application Note M513 for reel size information.

All sample boards include 5 loose parts.

^{*} Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



AC Electrical Specifications: $T_A = 25$ °C, $Z_0 = 50 \Omega$

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Insertion Loss	5 - 15 GHz 15 - 45 GHz 45 - 55 GHz	dB	_	0.3 0.6 1.0	_
Coupling	5 - 15 GHz 15 - 45 GHz 45 - 55 GHz	dB	_	23 18 25	_
Return Loss, S11 & S22	5 - 15 GHz 15 - 45 GHz 45 - 55 GHz	dB	_	35 30 17	_
Return Loss, S33	5 - 15 GHz 15 - 45 GHz 45 - 55 GHz	dB	_	22 17 12	_
Isolation	5 - 15 GHz 15 - 45 GHz 45 - 55 GHz	dB		45 33 38	_
Directivity	5 - 15 GHz 15 - 45 GHz 45 - 55 GHz	dB		22 15 13	_

Recommended Operating Conditions⁴

Parameter	Unit	Min.	Тур.	Max.
RF Input Power, port 3 (coupled port) ⁵	dBm	_	_	+12
RF Input Power, port 1 & 2 (through line) ⁵	dBm	_		+30
DC Current, port 3 (coupled port) ⁵	mA	_	_	16
DC Current, port 1 & 2 (through line) ⁵	А	_	_	1.8
Operating Temperature	°C	-55	_	+105

^{4.} All pins and frequencies.

Absolute Maximum Ratings^{6,7}

Parameter	Unit	Min	Max
RF Input Power, port 3 (coupled port)	dBm	_	+23
RF Input Power, port 1 & 2 (through line)	dBm	_	+41
DC Current, port 3 (coupled port)	mA	_	50
DC Current, port 1 & 2 (through line)	А	_	4.0
Storage Temperature	°C	-55	+105

^{6.} Exceeding any one or combination of these limits may cause permanent damage to this device.

^{5.} See derating graph.

^{7.} MACOM does not recommend sustained operation near these survivability limits.

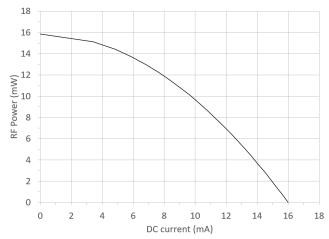
Directional Coupler 5 - 55 GHz



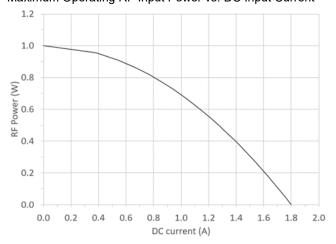
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De-Rating Curve @ T_A = +105°C, Ports 3, Coupled Port:

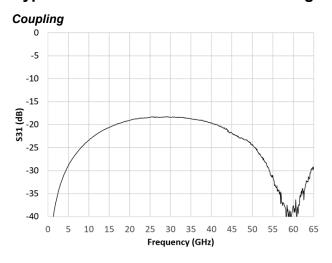
Maximum Operating RF Input Power vs. DC Input Current



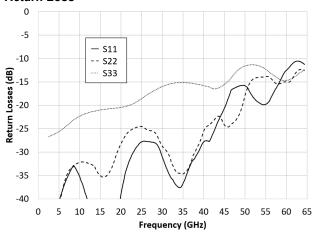
De-Rating Curve @ T_A = +105°C, Ports 1 and 2, Through Line: Maximum Operating RF Input Power vs. DC Input Current



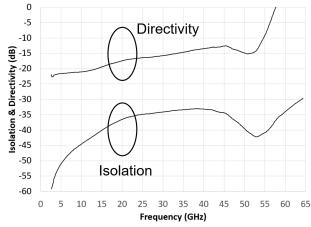
Typical Performance Curves: All Configurations



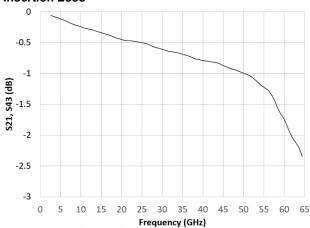
Return Loss



Isolation

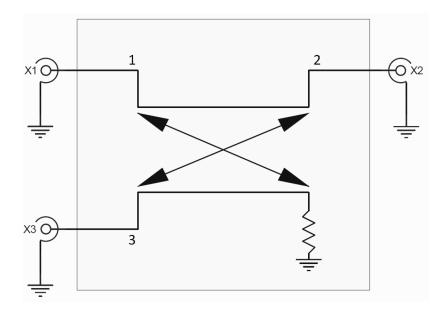


Insertion Loss





Application Schematic



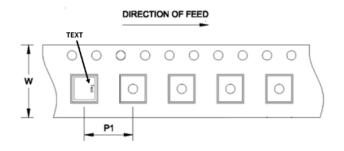
Mounting Techniques

Reference MACOM Application Note M538 for lead-free solder reflow recommendations. The gold plating on the back side of the die is 0.1 μ m thick. For a suitable solder attach ensure the PCB is gold plated with a thickness of between 0.05 - 0.15 μ m.

Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

Carrier Tape Orientation

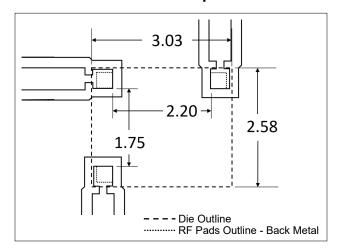


Tape & Reel Information

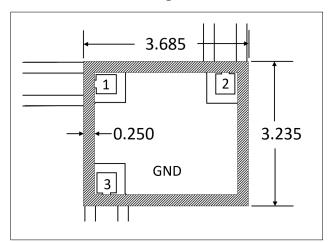
Parameter	Units	Value	
Qty per reel	_	100/500	
Reel Size	mm	178	
Tape Width	mm	12	
P1	mm	8	
Orientation	_	F3	
Reference Application Note ANI-019 for orientation			



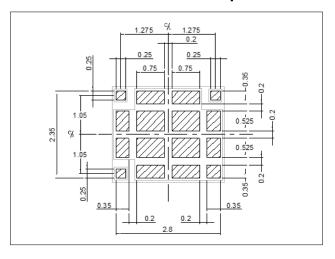
Recommended PCB footprint^{8,9}



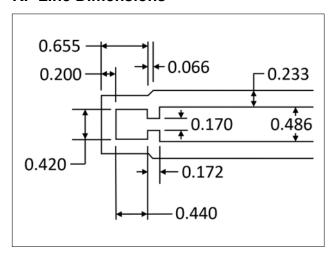
Solder Mask Coverage⁸



GND Metal Solder Paste Template^{8,9}



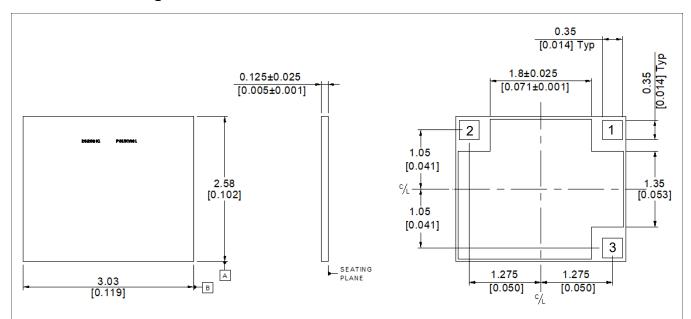
RF Line Dimensions^{8,10}



- 8. Dimensions in mm.
- 9. The exposed die backside GND metal must be connected to RF, DC and thermal ground.
- 10. Track dimensions apply to 44 μm thick copper on 0.254 mm Rogers 4350B.



Die Outline Drawing



NOTES:

- 1. UNLESS OTHERWISE SPECIFIED, ALL DIMENSIONS ARE mm[in]
- 2. UNLESS OTHERWISE SPECIFIED, ALL TOLERANCES ARE .XXX + 0.05[.002]

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